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MS AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Dated: May 22, 2007 Signature: N. Schibili
(Nikolaus P. Schibili)

EXPEDITED PROCEDURE

Group Art Unit: 1765

Docket No.: TESSERA 3.0-313

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: :
Light et al. :
Application No.: 10/771,252 : Group Art Unit: 1765
: :
: Filed: February 3, 2004 : Examiner: S. Ahmed
: :
For: METHOD FOR MAKING A :
MICROELECTRONIC PACKAGE USING :
PRE-PATTERNEDE, REUSABLE MOLDAND :
METHOD FOR MAKING THE MOLD :
:

AMENDMENT FILED CONCURRENTLY WITH
A REQUEST FOR CONTINUED EXAMINATION (RCE)

MS. AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action dated December 5, 2006, finally rejecting claims 1-40, please amend the above-identified U.S. patent application as follows:

ST 14P78

PT 14P78

14P78